



SamHop Microelectronics Corp.



SP2106

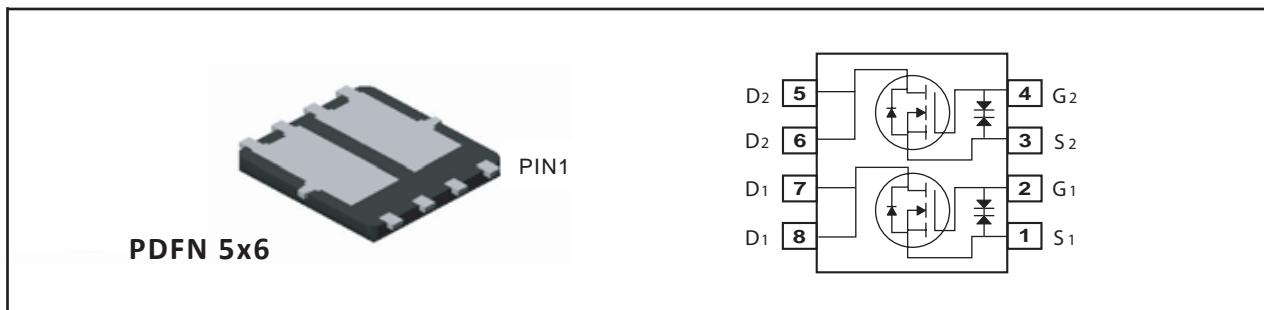
Ver 1.1

## Dual N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
VDSS	ID	RDS(ON) ( $\Omega$ ) Max
100V	1A	2.0 @ VGS=10V
		2.4 @ VGS=4.5V

### FEATURES

- Super high dense cell design for low RDS(ON).
- Rugged and reliable.
- Surface Mount Package.
- ESD Protected.



### ABSOLUTE MAXIMUM RATINGS ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter		Limit	Units
$V_{DS}$	Drain-Source Voltage		100	V
$V_{GS}$	Gate-Source Voltage		$\pm 20$	V
$I_D$	Drain Current-Continuous <sup>a</sup>	$T_A=25^\circ\text{C}$	1	A
		$T_A=70^\circ\text{C}$	0.8	A
$I_{DM}$	-Pulsed <sup>b</sup>		4.1	A
$E_{AS}$	Single Pulse Avalanche Energy <sup>d</sup>		0.25	mJ
$P_D$	Maximum Power Dissipation <sup>a</sup>	$T_A=25^\circ\text{C}$	2.5	W
		$T_A=70^\circ\text{C}$	1.6	W
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range		-55 to 150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	50	$^\circ\text{C/W}$
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## ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>OFF CHARACTERISTICS</b>						
BVDSS	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=10mA$	100			V
IDS	Zero Gate Voltage Drain Current	$V_{DS}=80V, V_{GS}=0V$			1	uA
IGSS	Gate-Body Leakage Current	$V_{GS} = \pm 20V, V_{DS}=0V$			$\pm 10$	uA
<b>ON CHARACTERISTICS</b>						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250uA$	1	1.8	3	V
RDS(ON)	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=0.5A$		1.6	2.0	ohm
		$V_{GS}=4.5V, I_D=0.5A$		1.9	2.4	ohm
gFS	Forward Transconductance	$V_{DS}=10V, I_D=0.5A$		1		S
<b>DYNAMIC CHARACTERISTICS</b> <sup>c</sup>						
Ciss	Input Capacitance	$V_{DS}=25V, V_{GS}=0V$ $f=1.0MHz$		64		pF
Coss	Output Capacitance			14		pF
CRSS	Reverse Transfer Capacitance			7		pF
<b>SWITCHING CHARACTERISTICS</b> <sup>c</sup>						
tD(ON)	Turn-On Delay Time	$V_{DD}=50V$ $I_D=0.5A$ $V_{GS}=10V$ $R_{GEN}=6\text{ ohm}$		7.6		ns
tr	Rise Time			7.2		ns
tD(OFF)	Turn-Off Delay Time			54		ns
tf	Fall Time			16		ns
Qg	Total Gate Charge	$V_{DS}=50V, I_D=0.5A, V_{GS}=10V$		2		nC
		$V_{DS}=50V, I_D=0.5A, V_{GS}=4.5V$		1.4		nC
Qgs	Gate-Source Charge	$V_{DS}=50V, I_D=0.5A,$ $V_{GS}=10V$		0.5		nC
Qgd	Gate-Drain Charge			0.7		nC
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
VSD	Diode Forward Voltage	$V_{GS}=0V, I_S=0.5A$		0.86	1.2	V
<b>Notes</b>						
a. Surface Mounted on FR4 Board, $t < 10\text{sec}$ .						
b. Pulse Test: Pulse Width $< 10\mu\text{s}$ , Duty Cycle $< 1\%$ .						
c. Guaranteed by design, not subject to production testing.						
d. Starting $T_J=25^\circ C, L=0.5\text{mH}, V_{DD}=50V$ . (See Figure13)						

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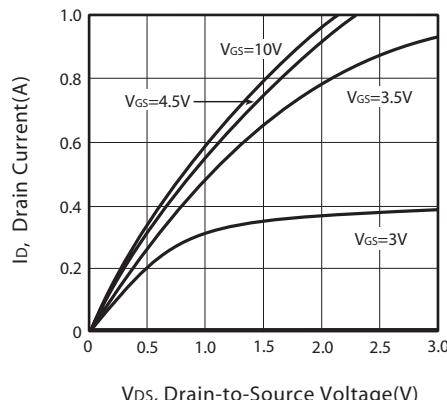


Figure 1. Output Characteristics

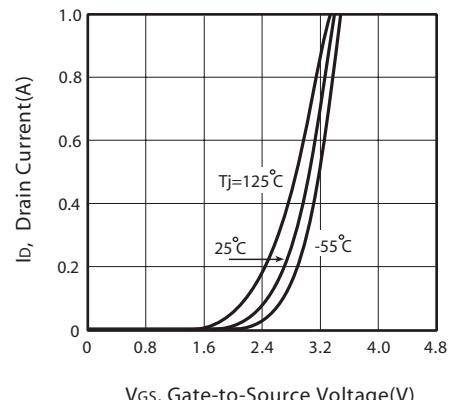


Figure 2. Transfer Characteristics

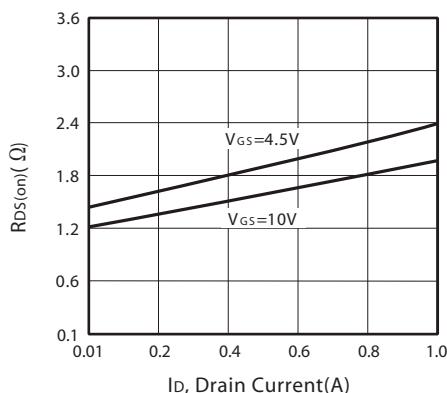


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

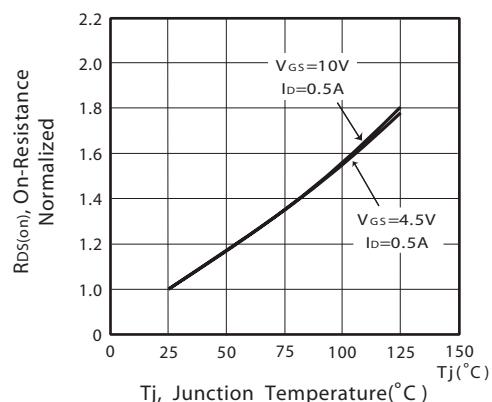


Figure 4. On-Resistance Variation with Drain Current and Temperature

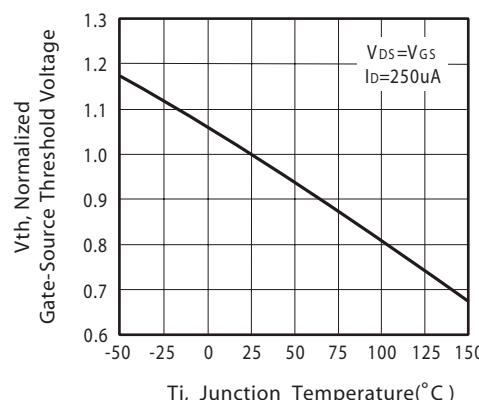


Figure 5. Gate Threshold Variation with Temperature

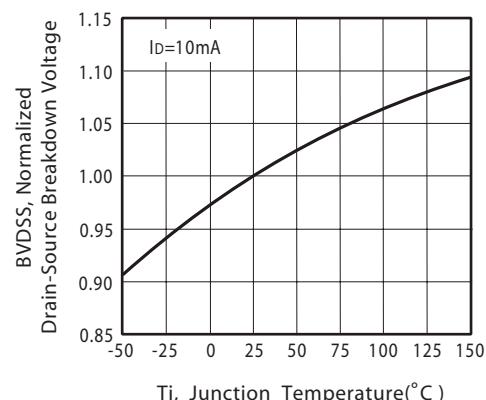
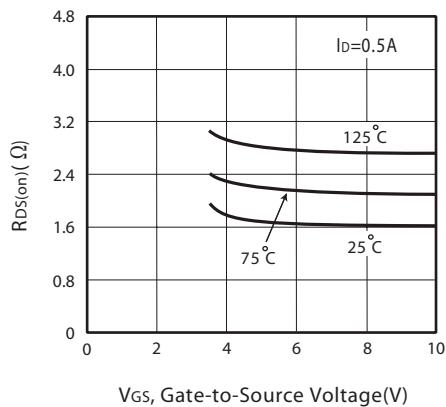


Figure 6. Breakdown Voltage Variation with Temperature

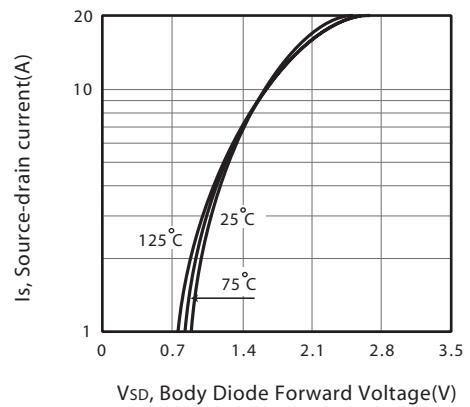
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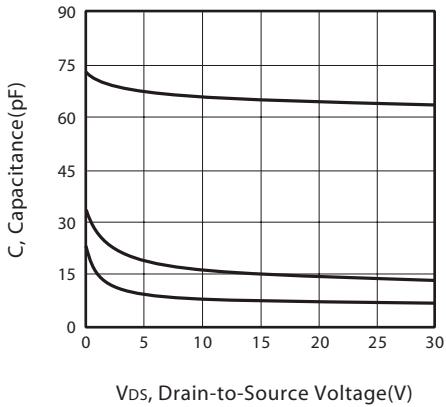
V<sub>GS</sub>, Gate-to-Source Voltage(V)

Figure 7. On-Resistance vs. Gate-Source Voltage



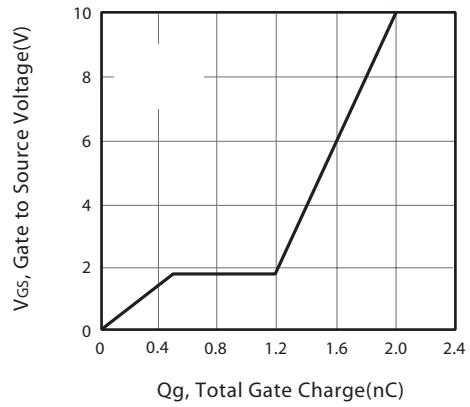
V<sub>SD</sub>, Body Diode Forward Voltage(V)

Figure 8. Body Diode Forward Voltage Variation with Source Current



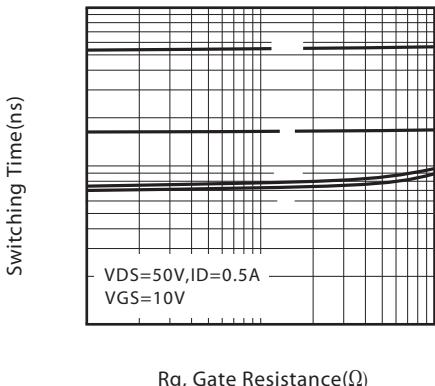
V<sub>DS</sub>, Drain-to-Source Voltage(V)

Figure 9. Capacitance



Q<sub>g</sub>, Total Gate Charge(nC)

Figure 10. Gate Charge



R<sub>g</sub>, Gate Resistance(Ω)

Figure 11. switching characteristics

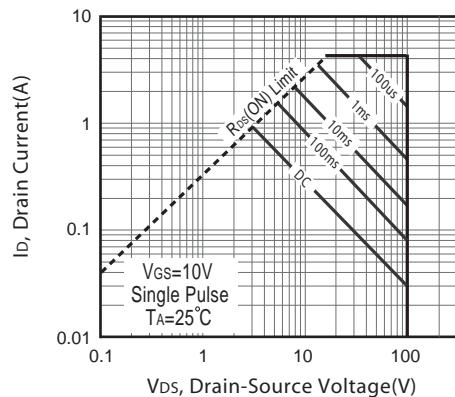
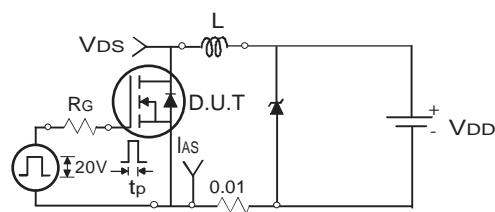


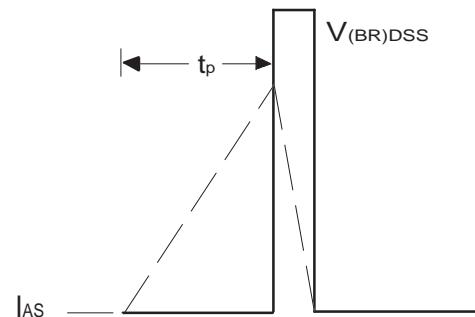
Figure 12. Maximum Safe Operating Area

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Uncamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

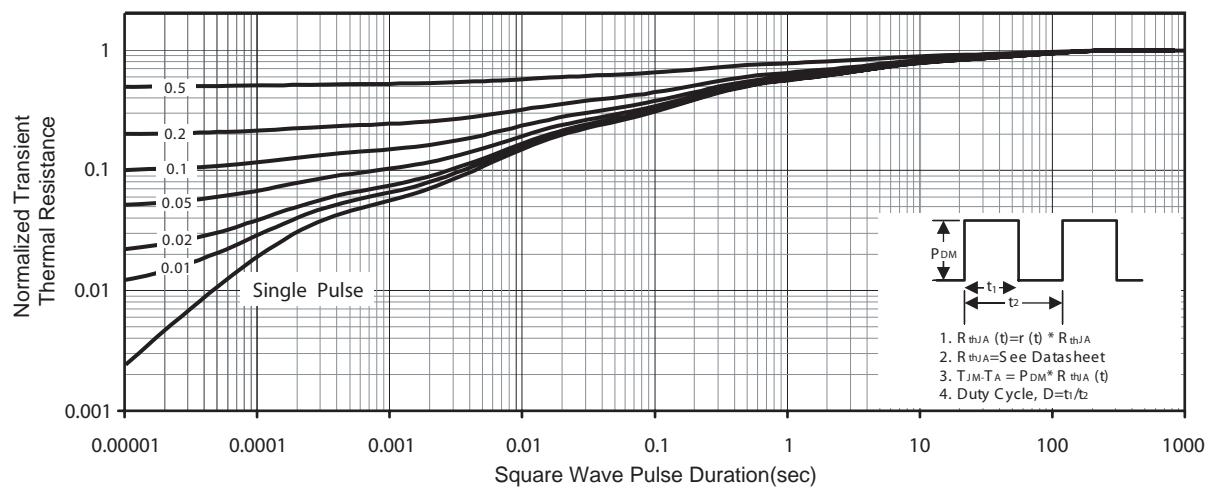
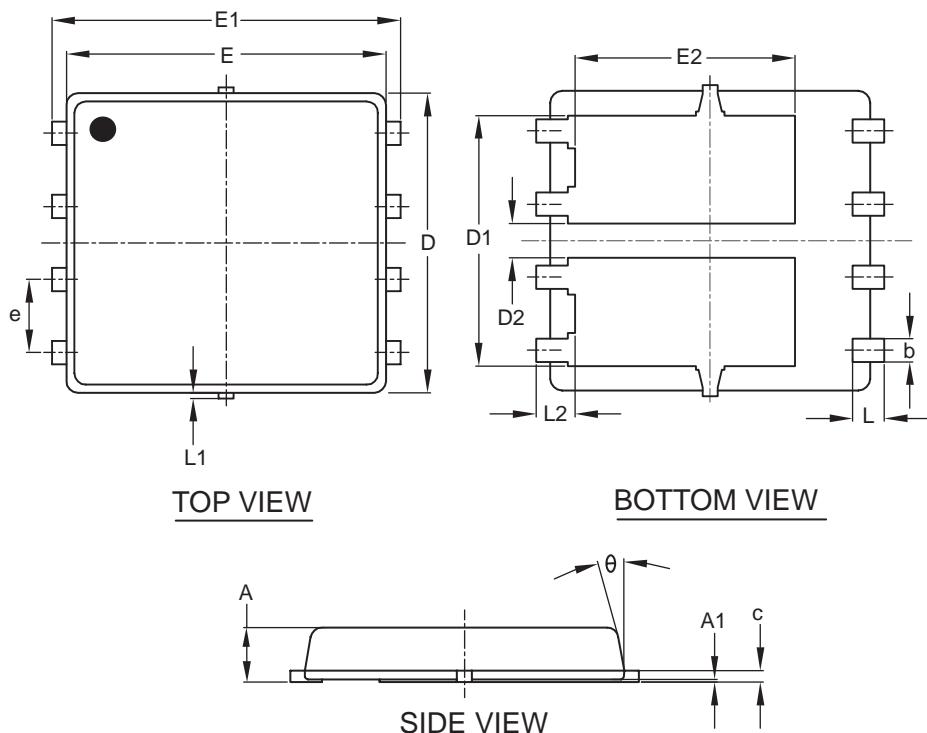


Figure 14. Normalized Thermal Transient Impedance Curve

## PACKAGE OUTLINE DIMENSIONS

**PDFN 5x6-8L**



SYMBOLS	MILLIMETERS		
	MIN	NOM	MAX
A	0.85	0.95	1.00
A1	0.00	—	0.05
b	0.30	0.40	0.50
c	0.15	0.20	0.25
D	5.20 BSC		
D1	4.35 BSC		
D2	0.50	0.60	0.75
E	5.55 BSC		
E1	6.05 BSC		
E2	3.82 BSC		
e	1.27 BSC		
L	0.45	0.55	0.65
L1	0.00	—	0.15
L2	0.68 REF		
θ	0°	—	10°

## TOP MARKING DEFINITION

### PDFN 5x6-8L

